



SPECIFICATIONS

Rated Current:1.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

Contact Material:Brass

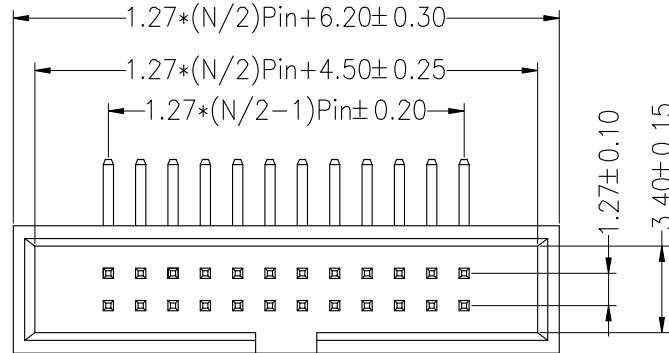
Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

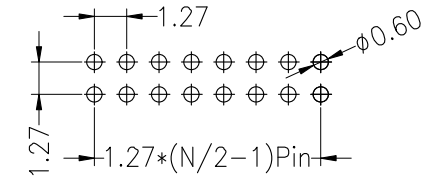
Resistance To Soldering Heat:

245°C±5°C, 10s(PBT insulator)

260°C±5°C, 10s(PA6T&PA9T&LCP insulator)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

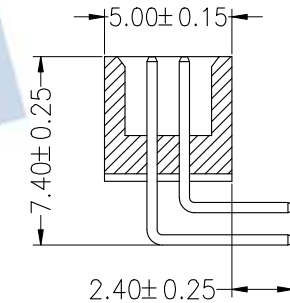
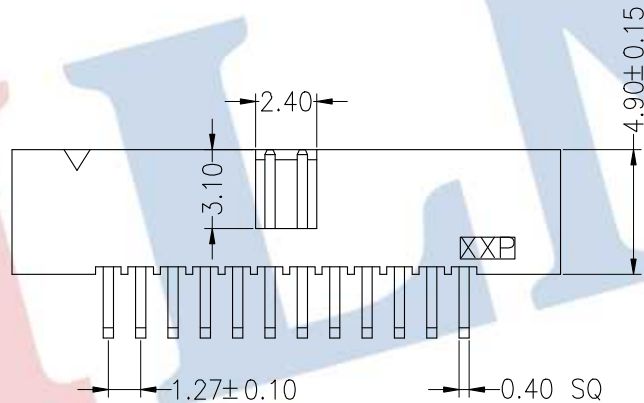
3230 XX R XX X B K00 X 0X

No. of Pins
10-100P

Contact Plating
G0:Gold Flash
G1:1u" Gold
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin

Insulator Material
Option
A=BK-PBT
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Packing
0=PE Bag
A=Tray
T=Tube
P=Tube+Cap



OPERATION

X.X ±0.30

X.XX ±0.20

X.XXX ±0.10

Angle ±3°

DIM TOL

DRAW

yi yusheng

14.10.18

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1

JILN® 深圳市锦凌电子有限公司
SHENZHEN JINLING ELECTRONICS CO.,LTD

Tel: 86-755-27483253 Fax: 86-755-2997-5588

PART NO.

3230XXRXXBK00X0X

TITLE:

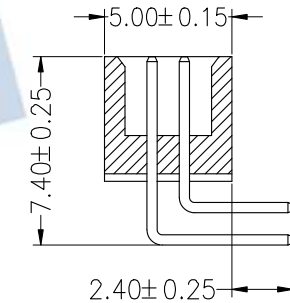
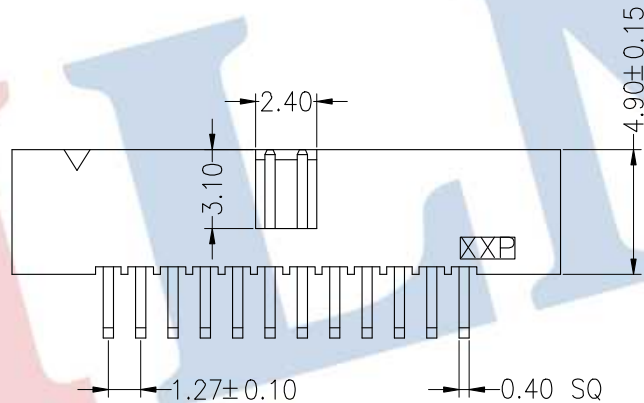
1.27Box Header NPin H4.9 90°

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